● General Description

The ZM027N03F combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

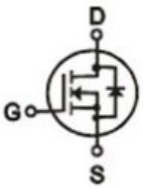
● Features

- ■ Advance high cell density Trench technology
- ■Low $R_{DS(ON)}$ to minimize conductive loss
- ■Low Gate Charge for fast switching
- ■Low Thermal resistance

●Application

- ■MB/VGA Vcore
- ■SMPS 2nd Synchronous Rectifier
- ■POL application
- ■BLDC Motor driver

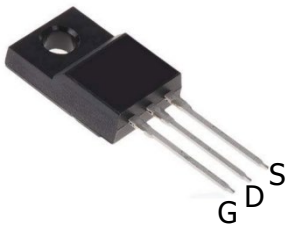
● Product Summary



V_{DS} =30V

$R_{DS(ON)}$ =2.7mΩ

I_D =80A



RoHS

TO-220F

●Ordering Information:

Part NO.	ZM027N03F
Marking	ZM027N03
Packing Information	Bulk Tube
Basic ordering unit (pcs)	500

●Absolute Maximum Ratings (T_C =25℃)

Parameter	**Symbol**	Rating	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	$I_{D@}T_C$=25℃	80	A
	$I_{D@}T_C$=75℃	61	A
	$I_{D\ @}T_C$=100℃	50	A
Pulsed Drain Current①	I_{DM}	210	A
Total Power Dissipation	$P_D@T_C$=25℃	120	W
Total Power Dissipation	$P_D@T_A$=25℃	5	W
Operating Junction Temperature	T_J	-55 to 150	℃
Storage Temperature	T_{STG}	-55 to 150	℃
Single Pulse Avalanche Energy	E_{AS}	180	mJ
Avalanche Current	I_{AS} I_{AR}	60	A

●Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}	-	-	1.1	°C/W
Thermal resistance, junction - ambient	R_{thJA}	-	-	25	°C/W
Soldering temperature, wave soldering for 10s	T_{sold}	-	-	265	°C

●Electronic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS} =0V, I_D =250uA	30			V
Gate Threshold Voltage	$V_{GS(TH)}$	V_{GS} =V_{DS}, I_D =250uA	1.2		2.5	V
Drain-Source Leakage Current	I_{DSS}	V_{DS}=30V, V_{GS} =0V			1.0	uA
Gate- Source Leakage Current	I_{GSS}	V_{GS}=±20V, V_{DS} =0V			±100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=24A		2.7	3.6	mΩ
		V_{GS}=4.5V, I_D=12A		4.1	5.5	mΩ
Forward Transconductance	g_{FS}	V_{DS} =25V, I_D=10A		30		s
Source-drain voltage	V_{SD}	Is=24A			1.28	V

●Dynamic Characteristics

Parameter	Symbol	Condition	Min.	Typ	Max.	Unit
Input capacitance	Ciss	f = 1MHz, V_{DS}=25V	-	2800	-	pF
Output capacitance	Coss		-	420	-	
Reverse transfer capacitance	Crss		-	280	-	
Gate Risistance	R_g	f = 1MHz		2.5		Ω
Total gate charge	Qg	V_{DD} = 25V, I_D = 8A, V_{GS} = 10V	-	27	-	nC
Gate - Source charge	Qgs		-	8.6	-	
Gate - Drain charge	Qgd		-	13.8	-	
Turn-ON Delay time	$t_{D(on)}$	V_{GS}=10V, V_{DS}=15V, R_G =3.3Ω, I_D =15A		12		ns
Turn-ON Rise time	t_r			44		ns
Turn-Off Delay time	$t_{D(off)}$			50		ns
Turn-Off Fall time	t_f			15		ns
Reverse Recovery Time	t_{RR}			5.8		ns

Charge Time	t_a	V_{DD} = 20 V, dIS/dt=100A/us, IS = 30 A		3.4		ns
Discharge Time	t_b			2.4		ns
Reverse Recovery Charge	Q_{RR}			1.6		nC

Note: ① Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% ;

Fig.1 Power Dissipation

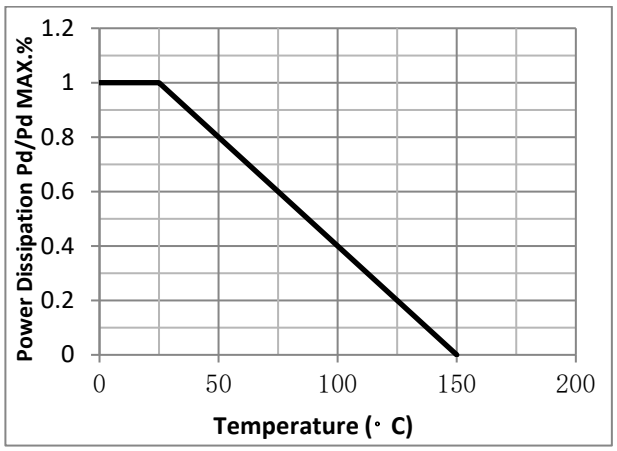


Fig.2 Typical output Characteristics

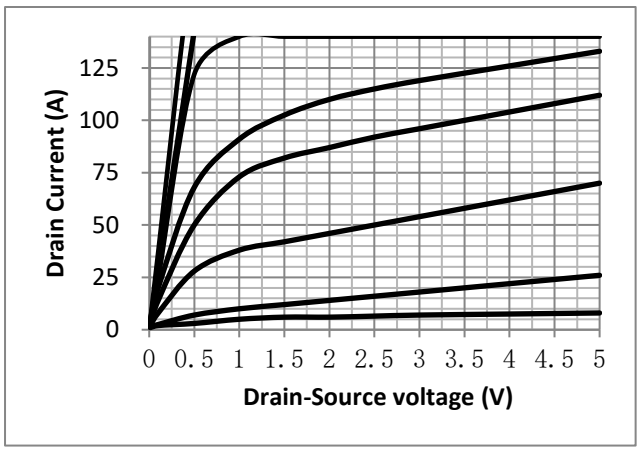


Fig.3 Threshold Voltage V.S Junction Temperature

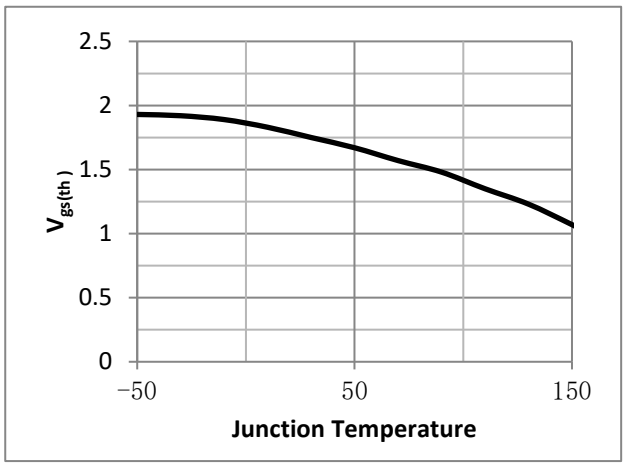


Fig.4 Resistance V.S Drain Current

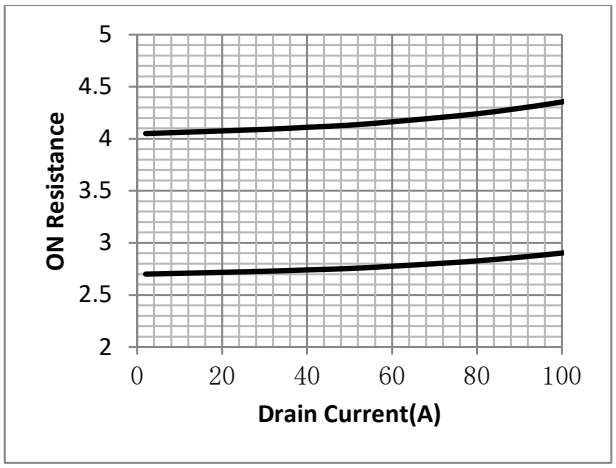


Fig.5 On-Resistance VS Gate Source Voltage

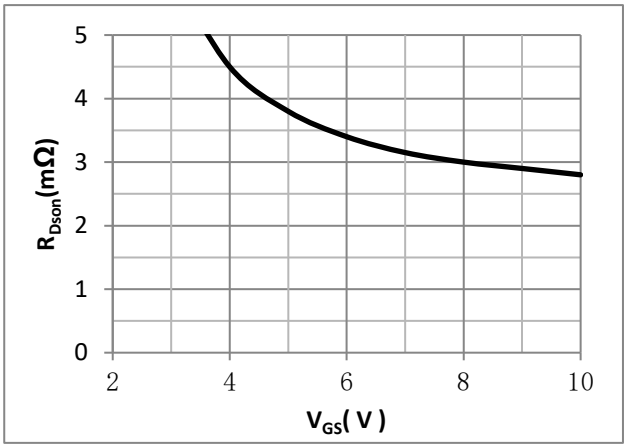


Fig.6 On-Resistance V.S Junction Temperature

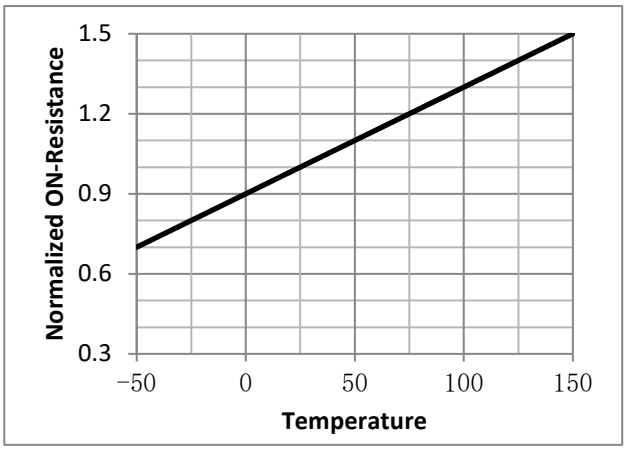


Fig.7 SOA Maximum Safe Operating Area

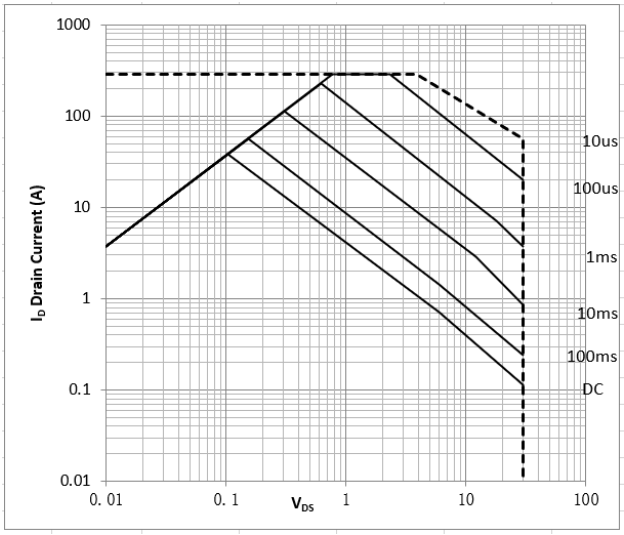


Fig.8 ID-Junction Temperature

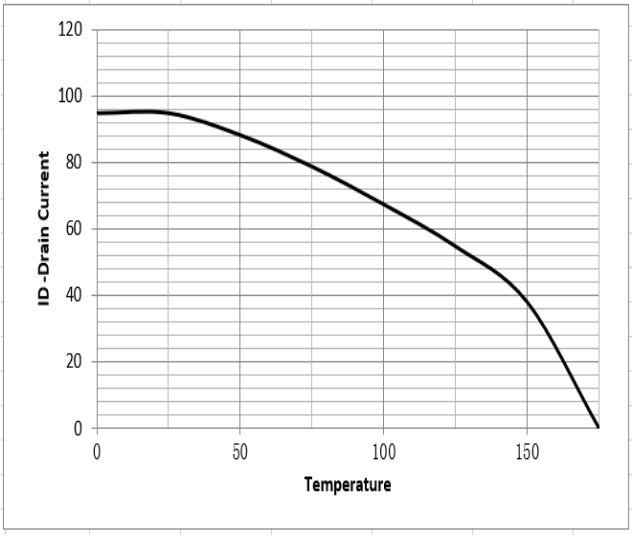


Figure 9. Diode Forward Voltage vs. Current

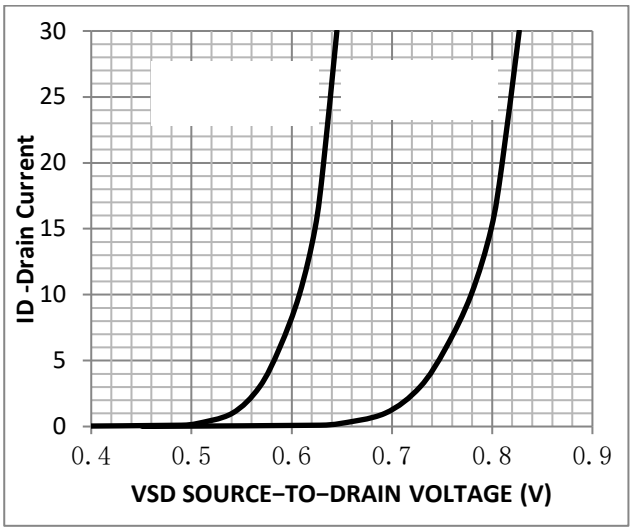


Figure 10. Transfer Characteristics

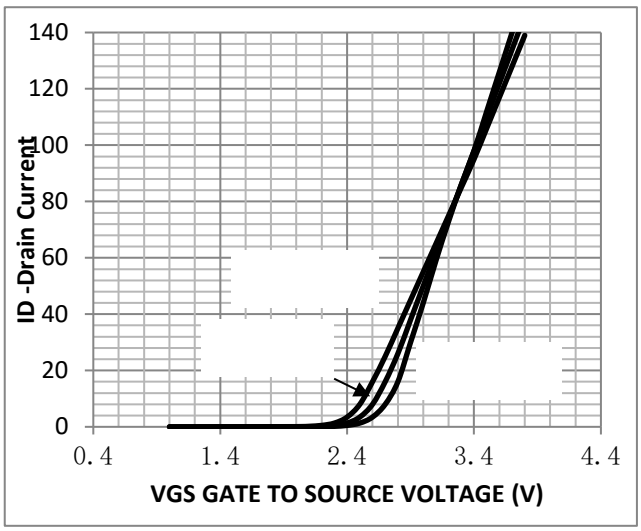


Figure 11. Gate–to–Source and Drain–to–Source Voltage vs. Total Charge

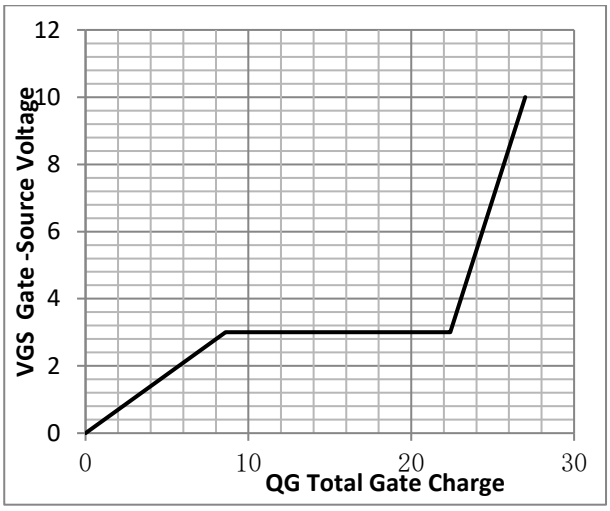


Fig.12 Capacitance Variation

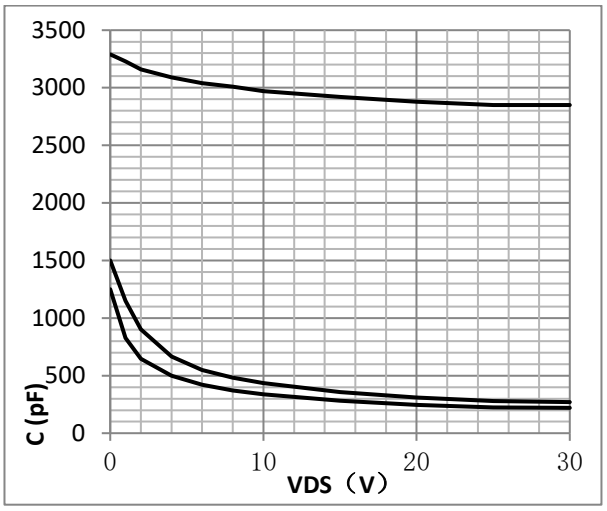


Fig.13 Switching Time Measurement Circuit

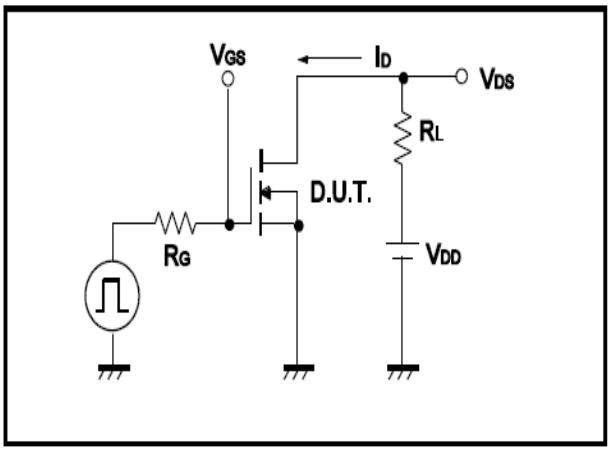


Fig.14 Gate Charge Waveform

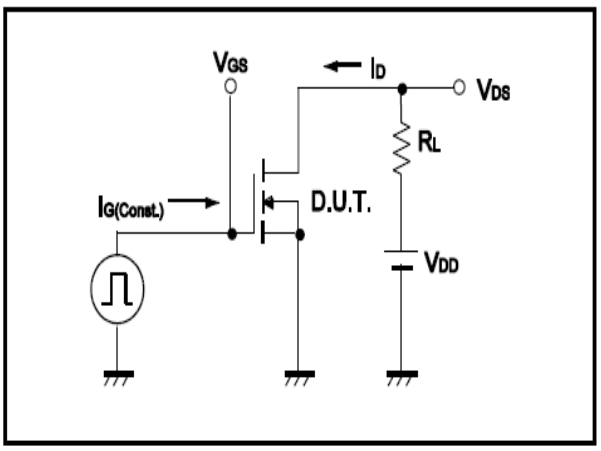


Fig.15 Avalanche Measurement Circuit

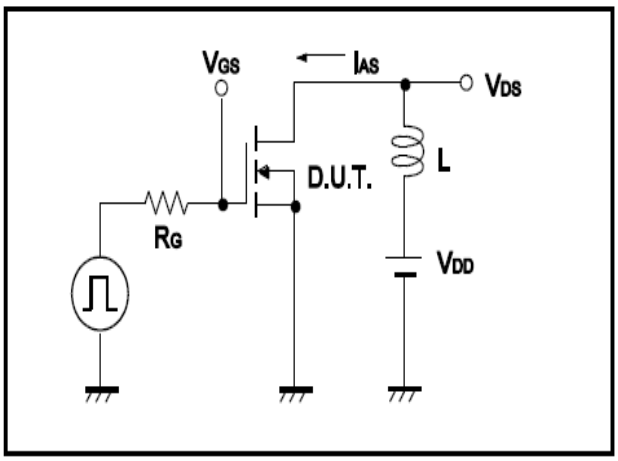


Fig.16 Avalanche Waveform

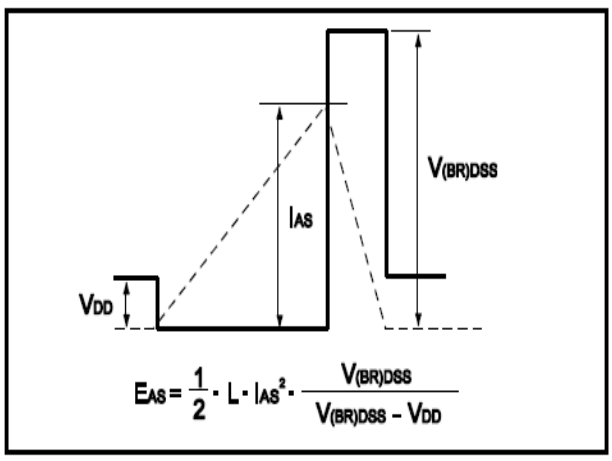
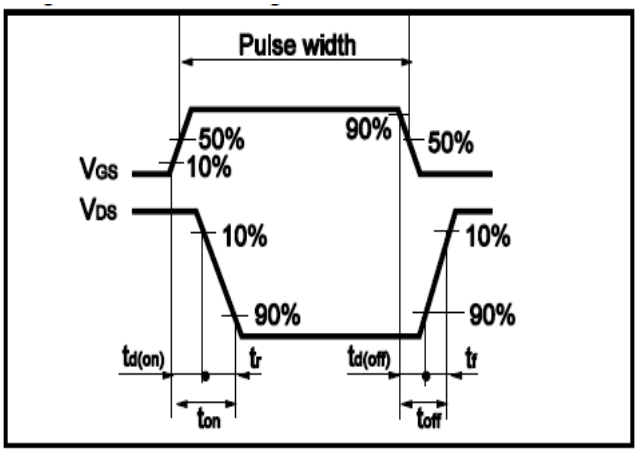


Fig.17 Gate Charge Waveform



Dimensions (TO-220F)

Unit：mm

SYMBOL	min	nom	max	SYMBOL	min	nom	max
C	4.50	4.70	4.90	b1	2.90	3.40	3.90
c	0.40	0.50	0.6	a	1.08	1.28	1.48
A	9.96	10.16	10.36	a1	0.70	0.80	0.9
B	15.67	15.87	16.07	E	2.34	2.54	2.74
B1	3.30	3.40	3.50	E1	2.34	2.54	2.74
R	3.08	3.18	3.28	C1	2.34	2.54	2.74
b	12.48	12.98	13.48	C2	2.56	2.76	2.96